

How to Make Manufacturing of LEDs Truly GREEN

Prasad N. Gadgil & Peter Dusza

Atomic Precision Systems Inc.
Santa Clara, CA



Overview

- Progression in Lighting Sources
- Typical HLED Device Structure
- Current HLED Manufacturing Process
- Precursors – TMG & Ammonia
- Ammonia in LED Manufacturing
- Issues: Ammonia Production & Purification
- Atomic Precision's Solutions
- Novel Reactor
- Alternative to Ammonia



Lighting Sources



5W, 20Yrs, \$15



15W, 3Yrs, \$3.0



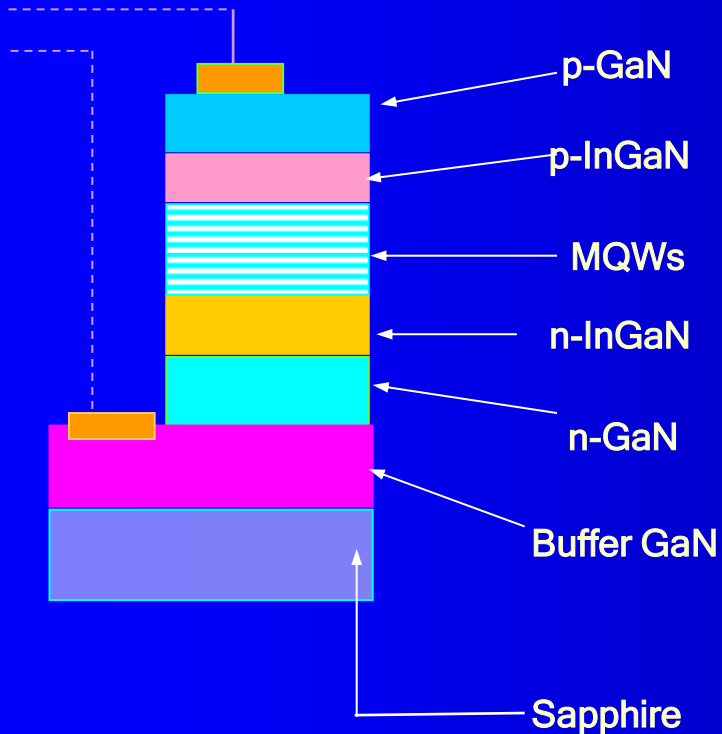
60W, 1.5 Yrs, \$1.0



HBLEDs - Current Applications



HBLED Device Structure

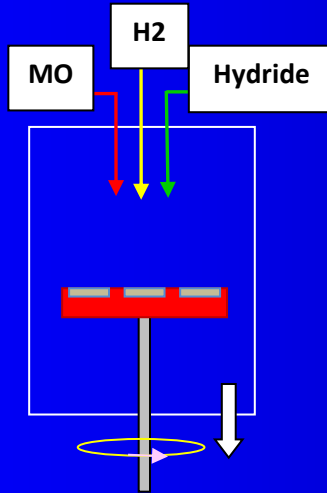


Device Layers

- Buffer GaN (4 to 6 μ)
- n-GaN & p-GaN (2 μ)
- InGaN: In & Ga % varies
- MQW: Quantum Wells
- Total stack: 8 – 10 μ

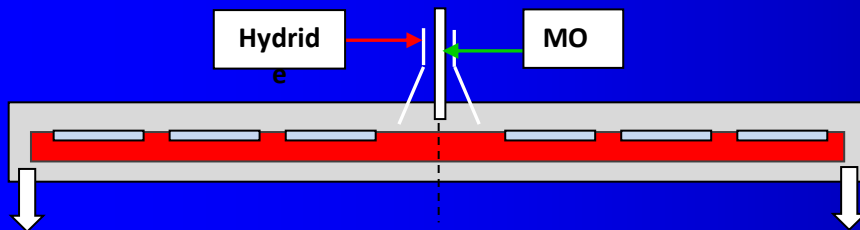


Current MOCVD Tool Configurations



Vendor - A

- Turbo-Disk; MO + Hydride
- 3-inch x 24 Wafer Capacity



Vendor - B

- Planetary Motion of Wafer
- 3-inch 24 Wafers
- Compact Design



MOCVD: Current Thin Film Process



- ✓ Process Temp. = 900 – 1,000 °C
- ✓ Chamber Pressure = x 100 mT
- ✓ Deposition Rate ~ 2 micron/h.
- ✓ Rigorous “O” Exclusion Required
- ✓ H₂ Added to Gas Mixture
- ✓ $\text{GaN} + \text{H}_2 \leftrightarrow \text{Ga} + \text{NH}_3$
- ✓ Ammonia added to “Reverse” GaN decomposition
- ✓ Typical Ammonia Flow Rate ~ 50 slpm
- ✓ Typical “Batch” Process Time ~ 5 h.



Volume of Ammonia Required

= $0.6 \times 50 \text{ slpm} \times 60 \text{ min/h} \times 24 \text{ h/day} \times 365 \text{ days/year}$

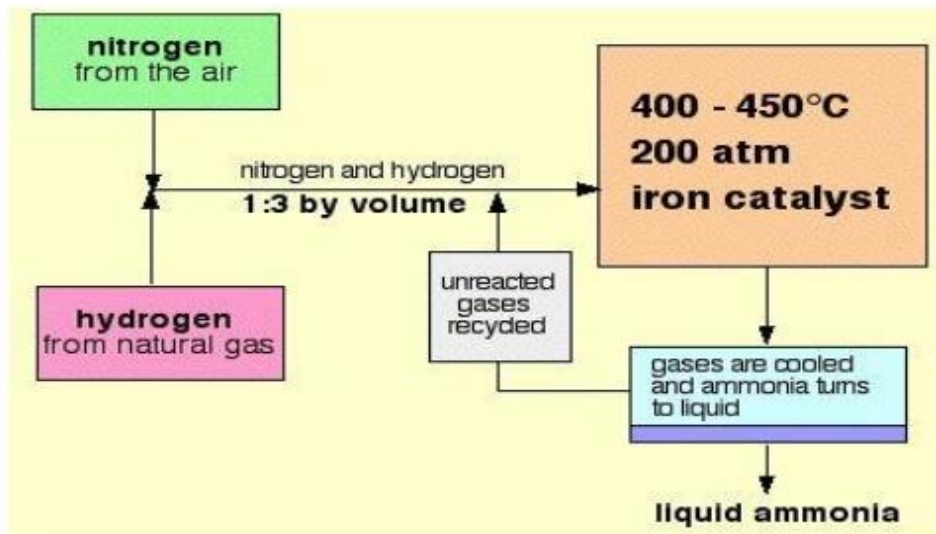
= 15,768,000 Liters/year/Tool
@ 60% Tool Uptime!

Hundreds of Tools Worldwide!



Industrial Ammonia Production

A Flow Scheme of Haber Process



Energy consumed in N_2 separation and H_2 generation



HBLLED Mfg: Required Ammonia Purity

Spec Gas Supplier	Total Purity %	H2O ppb	O2 ppb	CO ppb	CO2 ppb	Total ppb oxygen compounds
White Grade	99.99999	1	10	10	50	71
B	99.99999	60	30	30	50	150
C	99.99997	5	50	30	50	135
D	99.99995	100	50	50	100	300

Ref. : R. W. Ford, Gases & Instrumentation, pp. 26, May/June 2013.



Ammonia Supply in Manufacturing



Ref. : R. W. Ford, Gases & Instrumentation, pp. 26, May/June 2013.



Issues in Ammonia Supply

- Ammonia is a refrigerant
- During transport cools on expansion
- Couplings, elastomer seals freeze → icing
- Couplings, seals loosen when frozen
- Strong possibility for Re-entry of all “O”s
- Must be “Re-purified” before entry into MOCVD
- Additional cost and energy expended

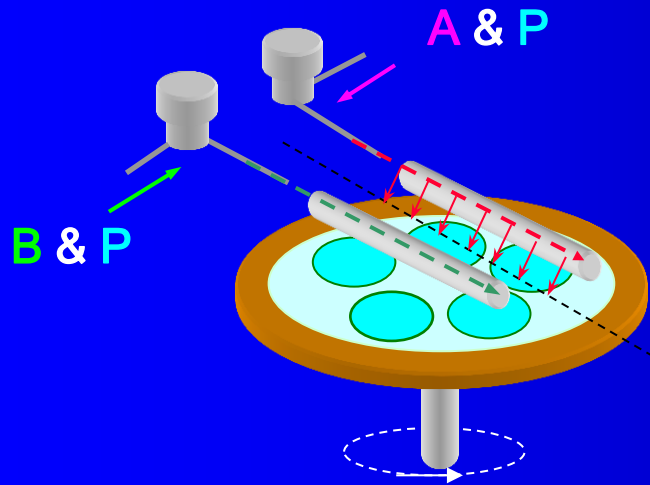


Solutions by Atomic Precision

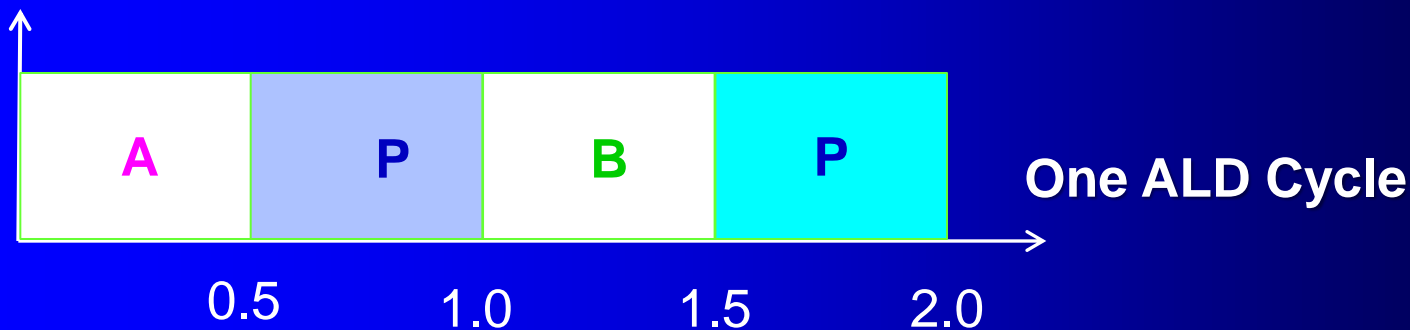
1. Novel High-speed Reactor
2. Ammonia **Free** chemistry
3. Substitute for $\text{Ga}(\text{CH}_3)_3$



1. Novel High-speed Reactor



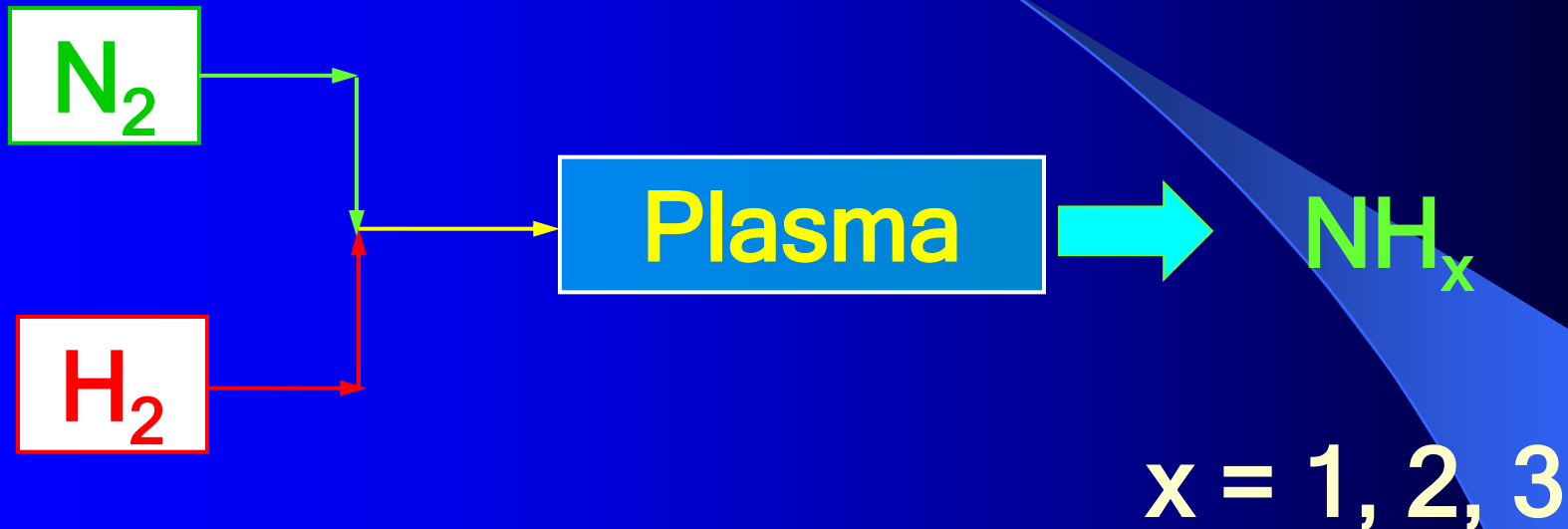
- ✓ Linear Injectors w/ Apertures
- ✓ Rapid Uniform Coverage
- ✓ ALD & CVD in One Chamber
- ✓ Thin & Thick Films
- ✓ Chemistry Flexibility



Prasad N. Gadgil, US Patent No. 6,812,157

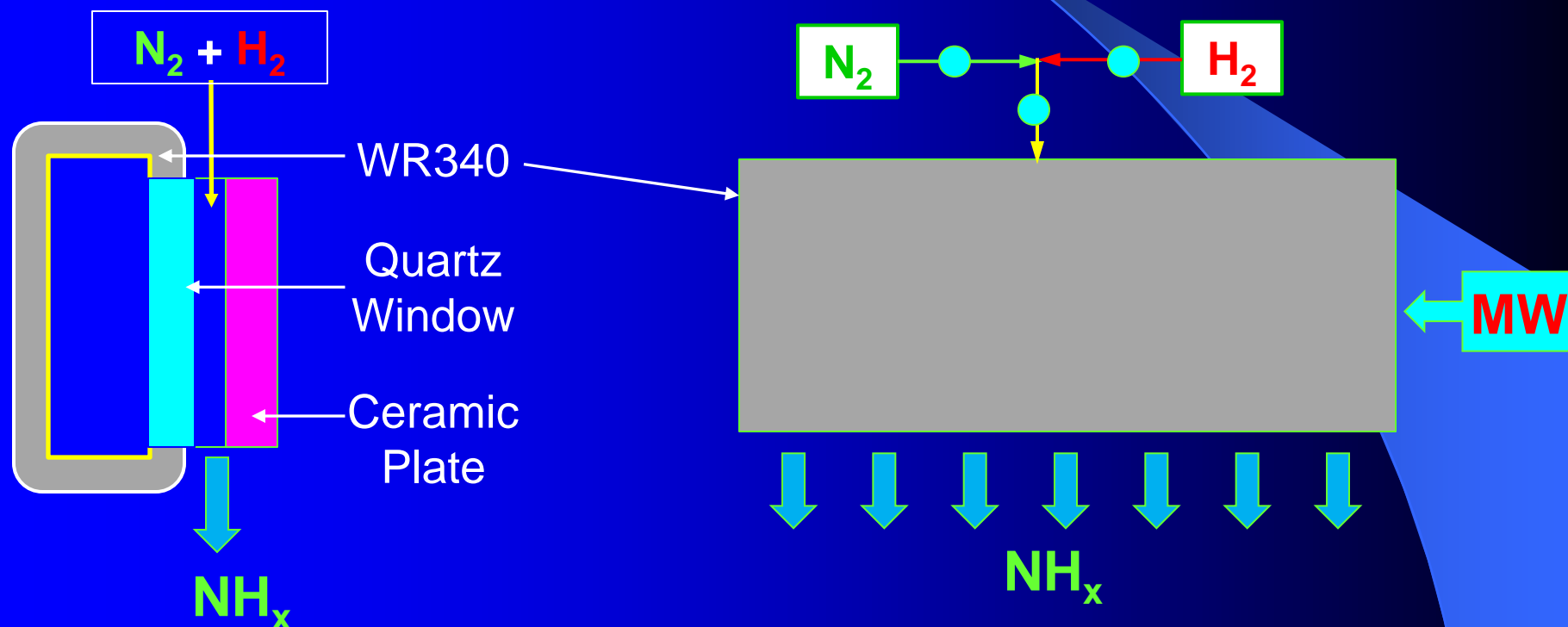


2. Ammonia **FREE** Chemistry



Ammonia FREE Chemistry

Low Volume Linear MW Plasma Applicator



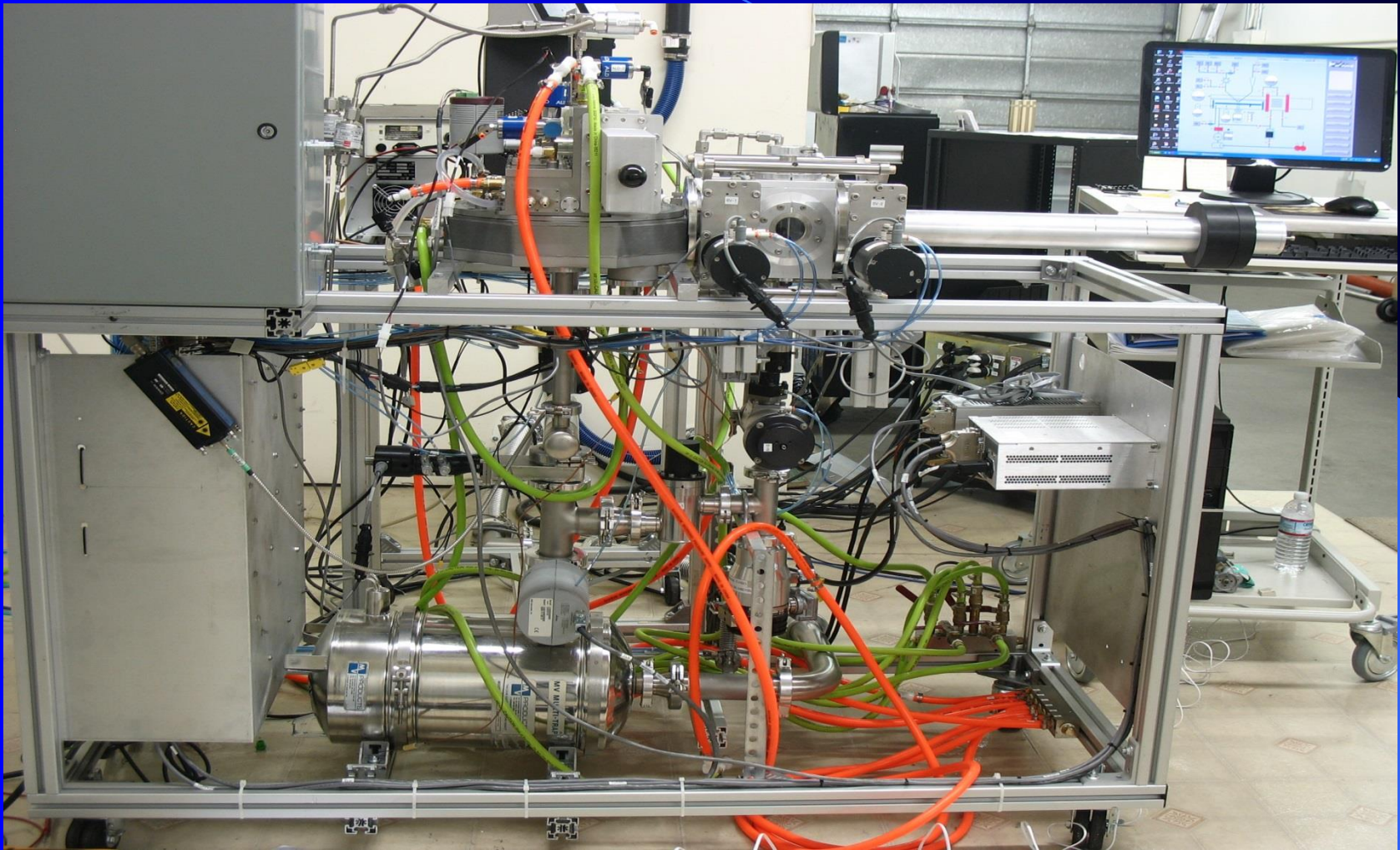
Replace $\text{Ga}(\text{CH}_3)_3$ by GaCl_3

	TMG	GaCl_3
State	Liquid	Solid
m. p. ($^{\circ}\text{C}$)	- 15.8	78
b. p. ($^{\circ}\text{C}$)	55.7	201.3
Cost (\$/g)	20*	< 1.0 §

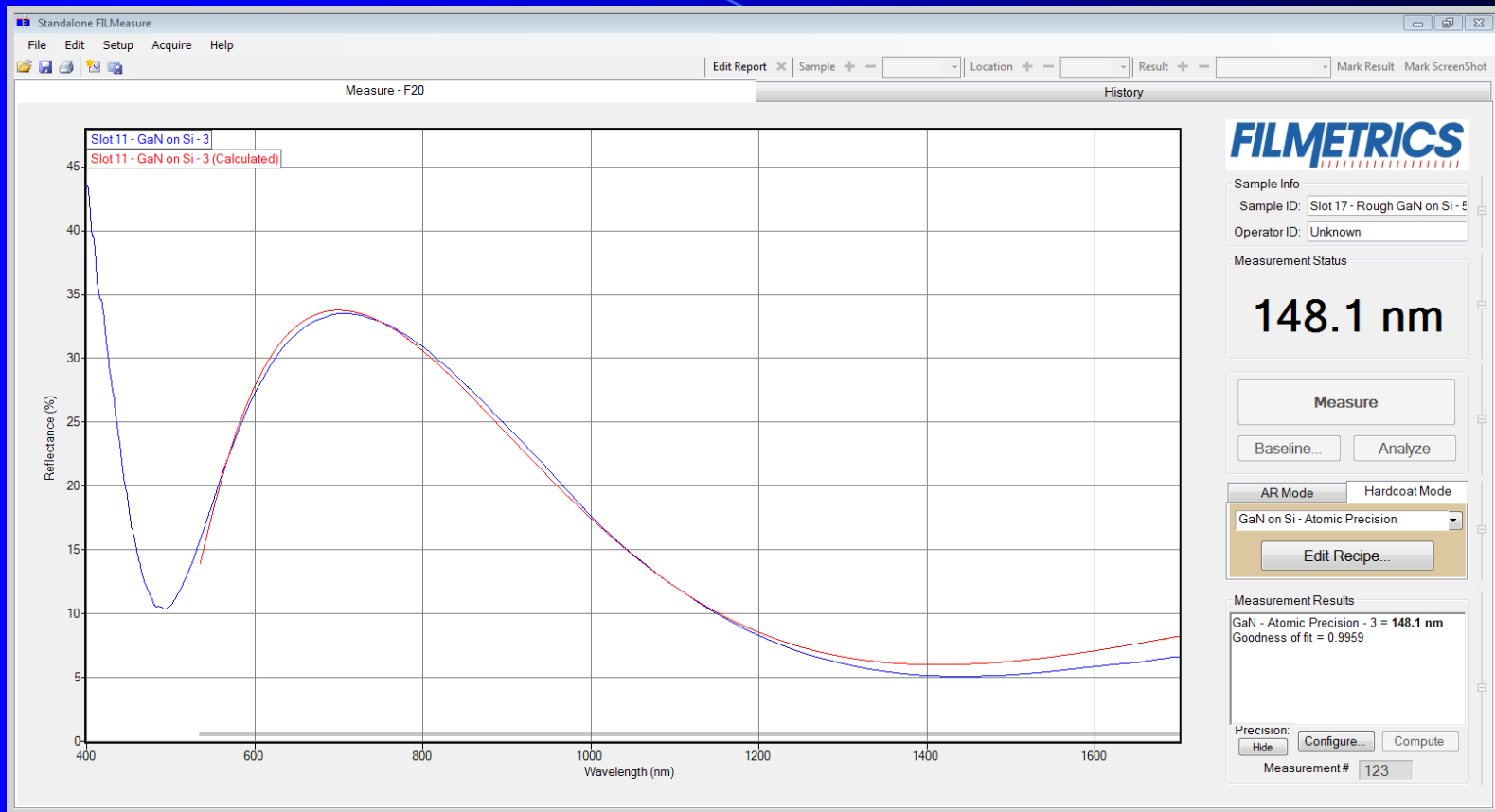
- * and §: Estimated bulk cost
- GaCl_3 can be molten and added via a linear injector



C&F GaN System – Atomic Precision



GaN: n&k Analysis



$N_2 = 25$ sccm, $H_2 = 75$ sccm, 500 °C, 700 mT, 500 W MW



Advantage – Atomic Precision

HBLED Production Technology - Factors	(MOCVD)	Atomic Precision
Chemical Cost (per g)	10	1x
Chemical Utilization Efficiency	~ 25 %	> 80%
Film Deposition Rate	~ 2 μ /h	~20 μ /h
Undesirable “C” in Film	Yes	No
Process Automation Potential	Marginal	Full
Product Yield	< 60%	N/A
Product Cost	10x	1x

† : Estimated.



Summary

- ✓ Enabling Equipment & Process Technology
- ✓ HBLED Cost Reduction by approx. 90%
- ✓ Environmentally Clean and GREEN Process

Thank You!

